



#14 Resp.
7/31/03
dmt

S/N: 09/832,884

7/18/2003

DOCKET NO.: L/M-102-DIV

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Steve M. Danziger, et al.**

Serial No.: **09/832,884** Art Unit: **2829**
Divisional of **09/321,565**

Filed: **April 12, 2001** Examiner: **Evan T. Pert**

For: **Method and Apparatus for Evaluating a Known Good Die Using Both Wire Bond and Flip-Chip Interconnects**

AMENDMENT

US Patent & Trademark Office
2011 South Clark Place
Customer Window, Mail Stop: **AF**
Crystal Plaza Two, Lobby, Room 1B03
Arlington, VA 22202

Sir:

This Amendment is responsive to the Advisory Action dated July 3, 2003. Claims 1 - 8 are pending and have been rejected.

RECEIVED
JUL 29 2003
TECHNOLOGY CENTER 2800